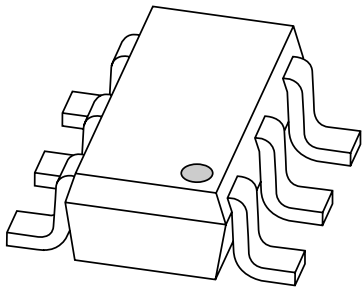


DATA SHEET



BZA418A Quadruple ESD transient voltage suppressor

Product specification

2002 Sep 02

Quadruple ESD transient voltage suppressor

BZA418A

FEATURES

- ESD rating >8 kV, according to IEC1000-4-2
- SOT457 surface mount package
- Common anode configuration
- Non-clamping range -0.5 to 18 V
- Maximum reverse peak power dissipation:
19.6 W at $t_p = 1$ ms
- Maximum clamping voltage at peak pulse current:
27 V at $I_{ZSM} = 0.7$ A.

APPLICATIONS

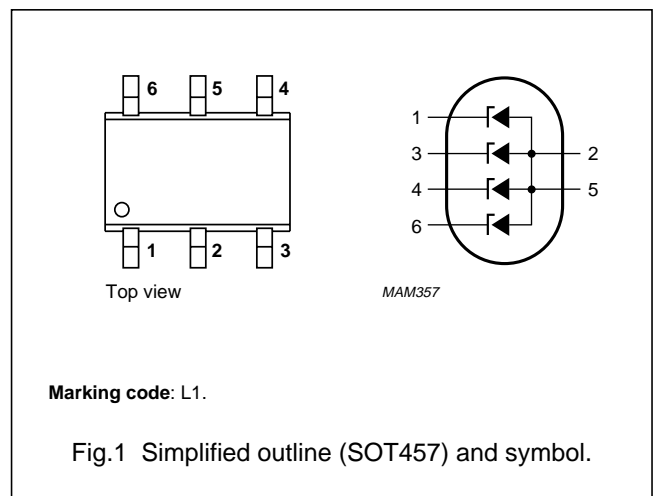
- Computers and peripherals
- Audio and video equipment
- Communication systems
- Medical equipment.

DESCRIPTION

Monolithic transient voltage suppressor diode in a six lead SOT457 (SC-74) package for 4-bit wide ESD transient suppression at 18 V level.

PINNING

PIN	DESCRIPTION
1	cathode 1
2	common
3	cathode 2
4	cathode 3
5	common
6	cathode 4



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
I_Z	working current	$T_s = 60$ °C; note 1	-	note 2	mA
I_F	continuous forward current	$T_s = 60$ °C	-	100	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 1$ ms; square pulse	-	3.75	A
I_{ZSM}	non-repetitive peak reverse current	$t_p = 1$ ms; square pulse; see Fig.2	-	0.7	A
P_{tot}	total power dissipation	$T_s = 60$ °C; see Fig.3	-	720	mW
P_{ZSM}	non repetitive peak reverse power dissipation	square pulse; $t_p = 1$ ms; see Fig.4	-	19.6	W
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		-65	+150	°C

Notes

1. T_s is the temperature at the soldering point of the anode pin.
2. DC working current limited by $P_{tot\ max}$.

Quadruple ESD transient voltage suppressor

BZA418A

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	one or more diodes loaded	125	K/W

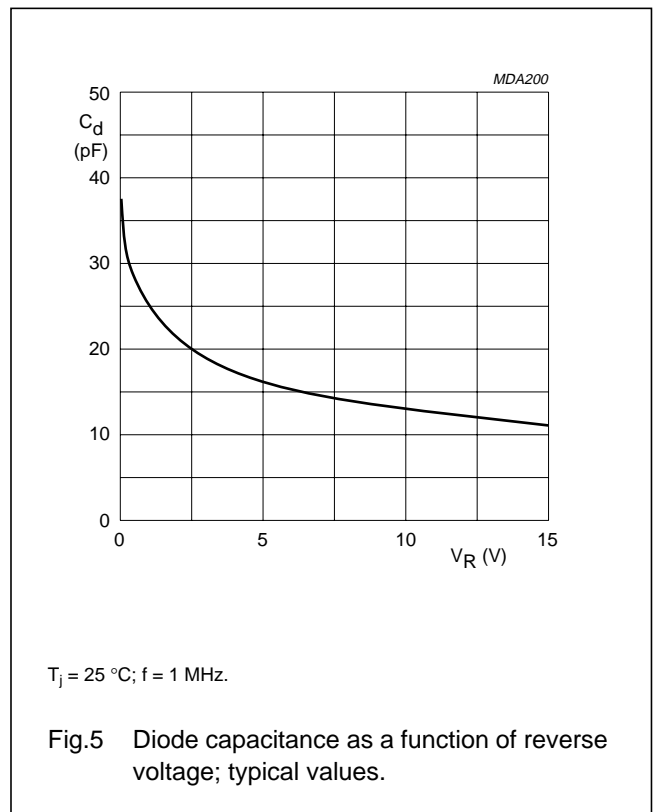
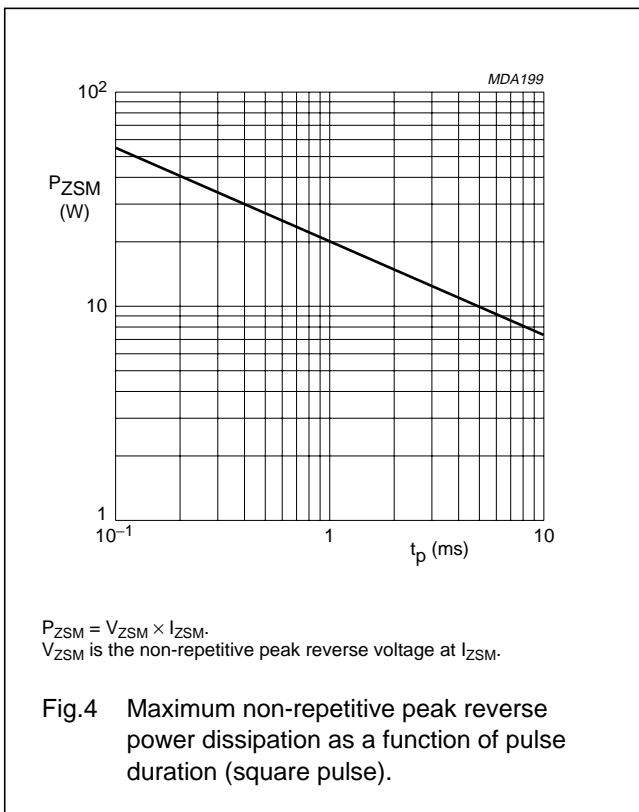
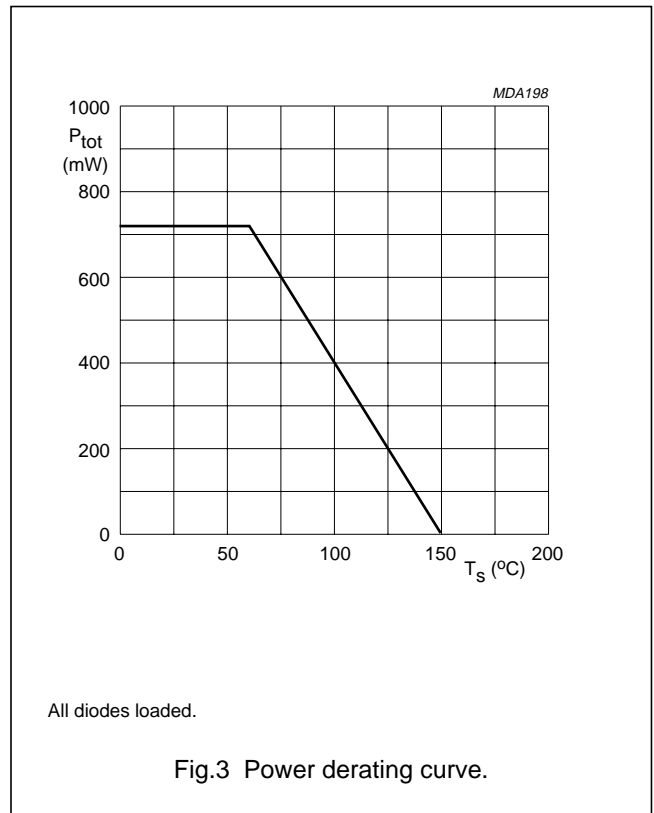
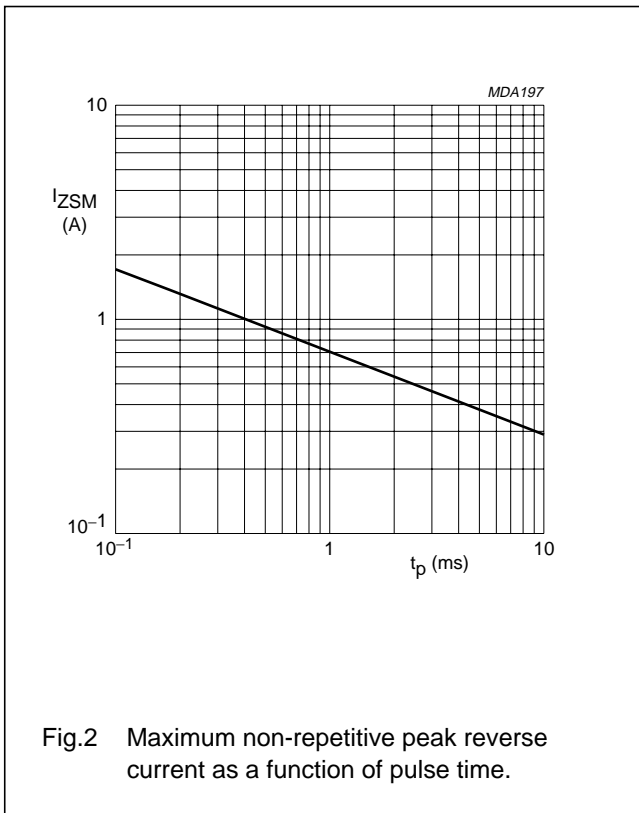
ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per diode						
V_Z	working voltage	$I_Z = 1\text{ mA}$	17.1	18	18.9	V
V_F	forward voltage	$I_F = 200\text{ mA}$	–	–	1.3	V
V_{ZSM}	non-repetitive peak reverse voltage	$I_{ZSM} = 0.7\text{ A}; t_p = 1\text{ ms}$	–	–	27	V
I_R	reverse current	$V_R = 14\text{ V}$	–	–	75	nA
r_{dif}	differential resistance	$I_Z = 1\text{ mA}$	–	–	125	Ω
S_Z	temperature coefficient of working voltage	$I_Z = 5\text{ mA}$	–	14.4	–	mV/K
C_d	diode capacitance	see Fig.5				
		$V_R = 0; f = 1\text{ MHz}$	–	–	48	pF
		$V_R = 13\text{ V}; f = 1\text{ MHz}$	–	–	14	pF

Quadruple ESD transient voltage suppressor

BZA418A



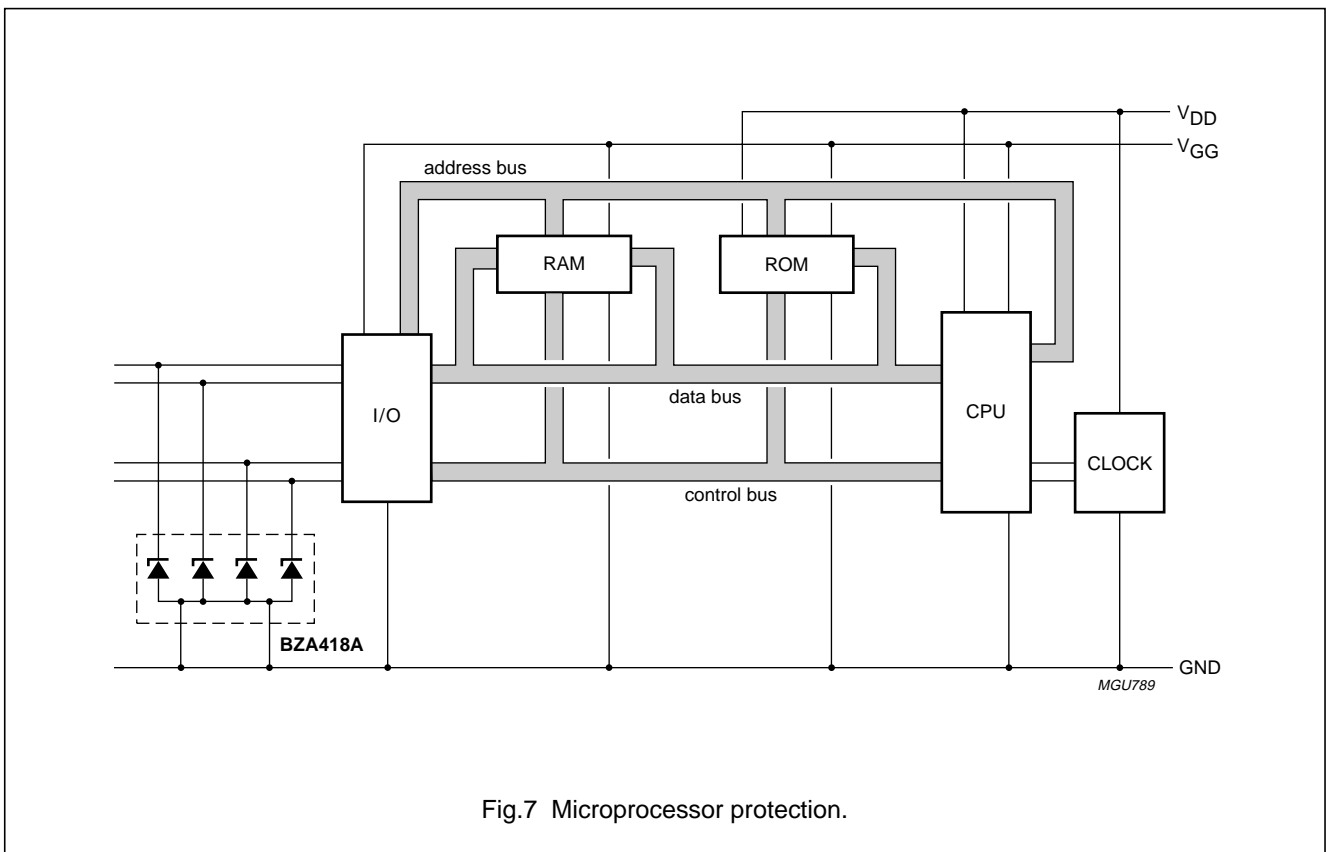
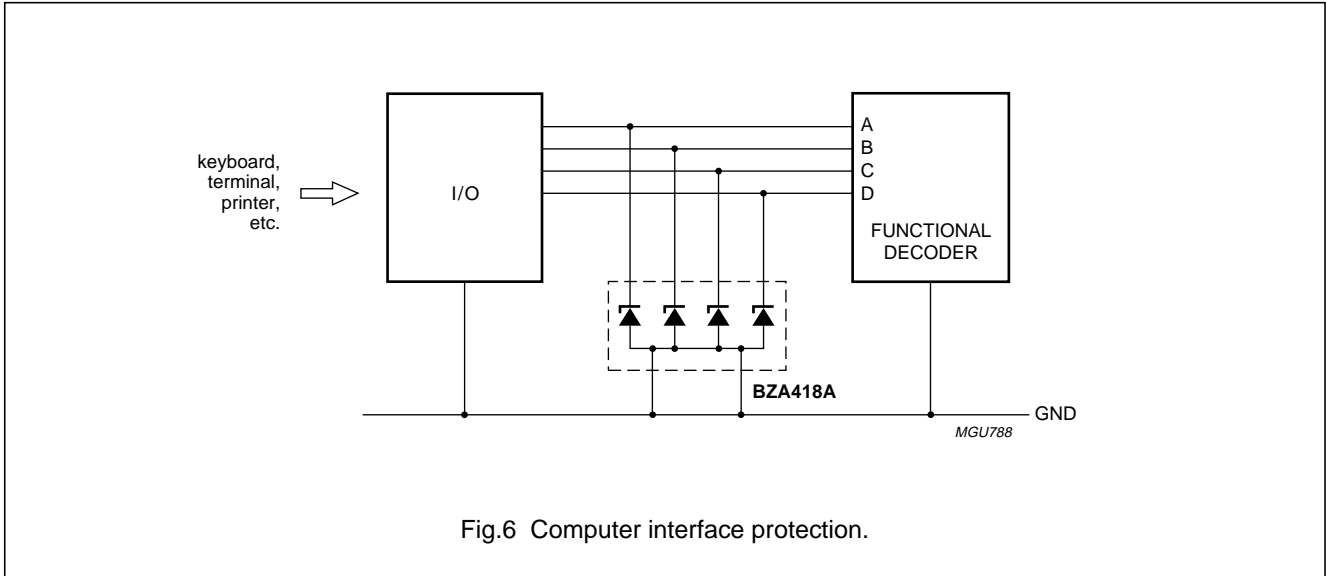
Quadruple ESD transient voltage suppressor

BZA418A

APPLICATION INFORMATION

Typical common anode application

A quadruple transient suppressor in a SOT457 package makes it possible to protect four separate lines using only one package. Two simplified examples are shown in Figs 6 and 7.



Quadruple ESD transient voltage suppressor

BZA418A

Device placement and printed-circuit board layout

Circuit board layout is of extreme importance in the suppression of transients. The clamping voltage of the BZA418A is determined by the peak transient current and the rate of rise of that current (di/dt). Since parasitic inductances can further add to the clamping voltage ($V = L di/dt$) the series conductor lengths on the printed-circuit board should be kept to a minimum. This includes the lead length of the suppression element.

In addition to minimizing conductor length the following printed-circuit board layout guidelines are recommended:

1. Place the suppression element close to the input terminals or connectors
2. Keep parallel signal paths to a minimum
3. Avoid running protection conductors in parallel with unprotected conductors
4. Minimize all printed-circuit board loop areas including power and ground loops
5. Minimize the length of the transient return path to ground
6. Avoid using shared transient return paths to a common ground point.

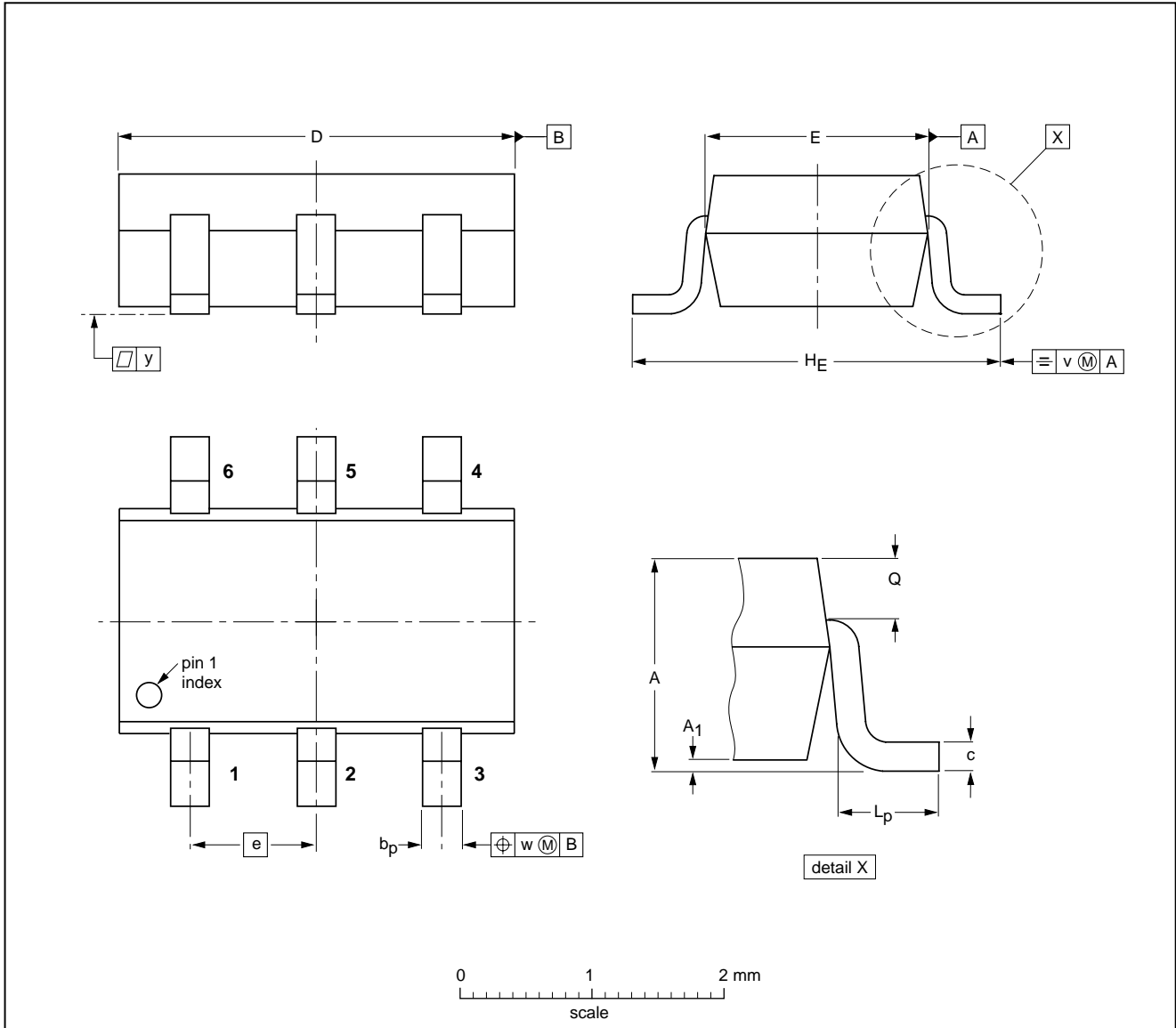
Quadruple ESD transient voltage suppressor

BZA418A

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b _p	c	D	E	e	H _E	L _p	Q	v	w	y
mm	1.1 0.9	0.1 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT457			SC-74			-97-02-28- 01-05-04

Quadruple ESD transient voltage suppressor

BZA418A

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Quadruple ESD transient voltage suppressor

BZA418A

NOTES

Quadruple ESD transient voltage suppressor

BZA418A

NOTES

Quadruple ESD transient voltage suppressor

BZA418A

NOTES

Philips Semiconductors – a worldwide company

Contact information

For additional information please visit <http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

© Koninklijke Philips Electronics N.V. 2002

SCA74

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

613514/01/pp12

Date of release: 2002 Sep 02

Document order number: 9397 750 10098

Let's make things better.

**Philips
Semiconductors**



PHILIPS